HFZT

SBT40L100CG

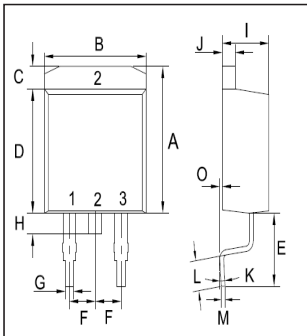
TO-263 Plastic-Encapsulate Transistors

FEATURES

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
  Soft, Fast Switching Capability
- Case Material: Molded Plastic, UL Flammability
  Ciassification Rating 94V-0

MECHANICAL DATA

- Case: TO-263 molded plastic body
- Terminals: Matte Tin Finish annealed over Copper
  leadframe Solderable per MIL-STD-202, Method 208
- Packing: 50pcs/Tube 800pcs/Reel



TO-263 (D^2 PAK)
Unit:mm

DIM	MIN	MAX
A	10.44	10.84
B	9.81	10.21
C	1.44	1.84
D	8.80	9.20
E	4.46	4.66
F	2.44	2.64
G	0.61	1.01
H	0.70	1.30
I	4.27	4.87
J	1.07	1.47
K	0°	8°
L	2.10	2.50
M	0.30	0.46
O	0	0.25

MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)Single phase,half wave,60 Hz,resistive or inductive load.
For capacitive load,derate by 20%.

PARAMETER		SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage		V_{RRM}	100	V
Maximum rms voltage		V_{RMS}	70	V
Maximum average forward rectified current	per device per diode	$I_{F(AV)}$	40 20	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load	per diode	I_{FSM}	300	A
Typical thermal resistance per diode	(Note 1)	$R_{\Theta JC}$	2	°C/W
Operating junction temperature range		T_J	-55 to + 150	°C
Storage temperature range		T_{STG}	-55 to + 150	°C

Note : 1. Mounted on infinite heatsink.

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Breakdown voltage per diode	V_{BR}	I_R=0.5mA		100	-	-	V
Instantaneous forward voltage per diode	V_F	I_F=5A I_F=10A I_F=20A	T_J=25°C	- - -	0.46 0.55 0.65	- - 0.70	V
		I_F=5A I_F=10A I_F=20A	T_J=125°C	- - -	0.38 0.50 0.55	- - -	V
Reverse current per diode	I_R	V_R=70V		- -	5 6	- -	μA mA
		V_R=100V	T_J=25°C T_J=125°C	- -	- 12	100 -	μA mA

RATINGS AND CHARACTERISTIC CURVES

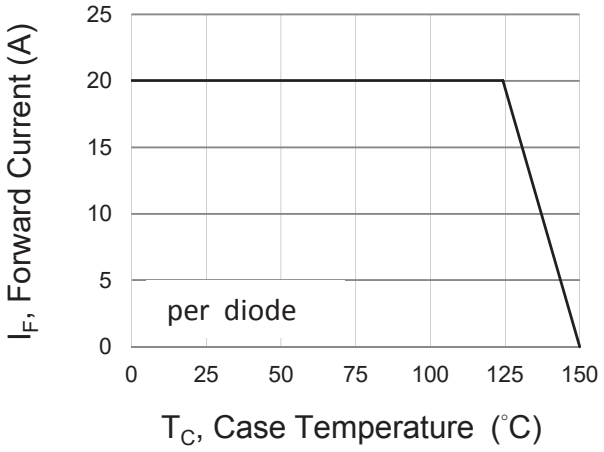


Fig.1 Forward Current Derating Curve

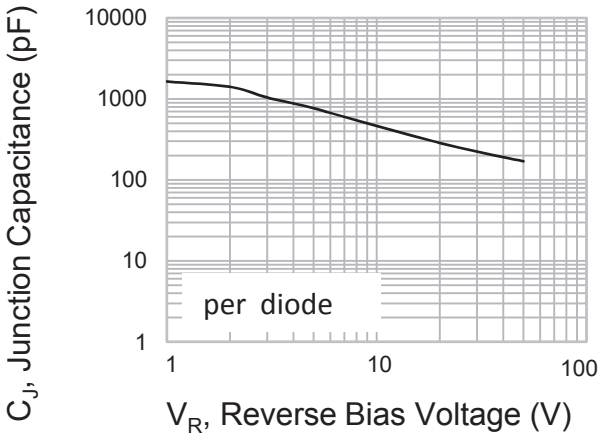


Fig.2 Typical Junction Capacitance

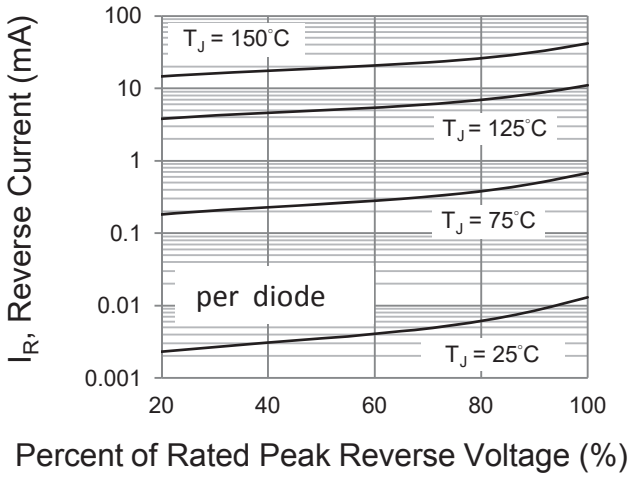


Fig.3 Typical Reverse Characteristics

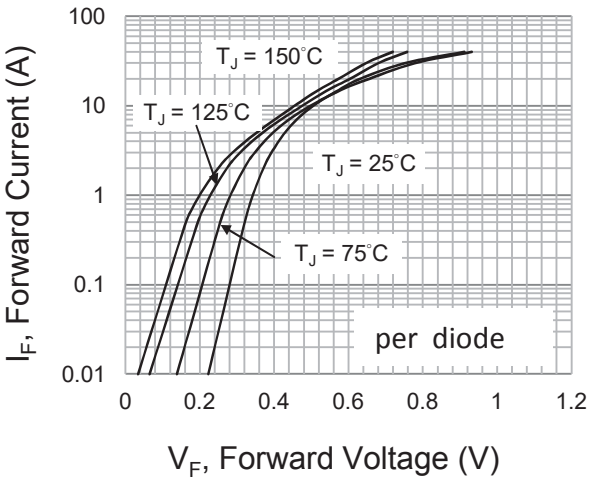


Fig.4 Typical Forward Characteristics